

### STW58N60DM2AG-VB Datasheet

N-Channel 600V (D-S) Super Junction Power MOSFET

PRODUCT SUMMA	RY	
V <sub>DS</sub> (V) at T <sub>J</sub> max.	600	)
R <sub>DS(on)</sub> at 25 °C (Ω)	$V_{GS} = 10 V$	0.060

### **FEATURES**

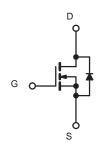
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)

### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting



TO-247



N-Channel MOSFET

<b>T</b>	10
Тор	View

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> :	= 25 °C, unle	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V <sub>DS</sub>	600	V		
Gate-Source Voltage			V <sub>GS</sub>	± 30	v	
Continuous Drain Current (T 150 °C)	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	1-	47		
Continuous Drain Current ( $T_J = 150 \ ^{\circ}C$ )	VGS at TO V	$T_C = 100 \ ^\circ C$	I <sub>D</sub>	29	A	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	140		
Linear Derating Factor				1.67	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>		E <sub>AS</sub>	850	mJ		
Maximum Power Dissipation		PD	510	W		
Operating Junction and Storage Temperature Range	Э		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-Source Voltage Slope	T <sub>J</sub> = 125 °C		al) / / alt	50	V/ns	
Reverse Diode dV/dt <sup>d</sup>		dV/dt	15	v/ns		
Soldering Recommendations (Peak Temperature) <sup>c</sup>	for 1	10 s		260	°C	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature. b.  $V_{DD} = 100 \text{ V}$ , starting  $T_J = 25 \text{ °C}$ , L = 30mH,  $R_g = 25 \Omega$ ,  $I_{AS} = 24A$ .

c. 1.6 mm from case. d.  $I_{SD} \le I_D$ , dl/dt = 100 A/µs, starting  $T_J$  = 25 °C.



## STW58N60DM2AG-VB

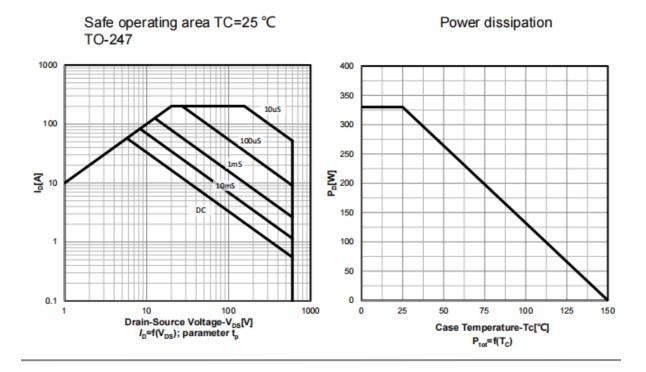


PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-		62				
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	- 0.3			°C/W		°C/W	
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, u	nless otherwi	ise noted)						
PARAMETER	SYMBOL			IONS	MIN.	TYP.	MAX.	UNIT
Static		1						
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> :	= 0 V, I <sub>D</sub> =	1 mA	600	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$			, I <sub>D</sub> = 1 mA	-	0.70	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>		= V <sub>GS</sub> , I <sub>D</sub> =	-	2.5	-	4.5	V
	GO(III)	$V_{GS} = \pm 20 V$		-	-	± 100	nA	
Gate-Source Leakage	I <sub>GSS</sub>		$V_{GS} = \pm 30$		-	-	± 1	μA
Zero Gate Voltage Drain Current			= 600V, V <sub>G</sub>		-	-	1	
	I <sub>DSS</sub>			$V_{GS} = 0 V, T_J = 125 °C$		-	100	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V		I <sub>D</sub> =16A	-	0.060	-	Ω
Forward Transconductance		V <sub>DS</sub>	= 30 V, I <sub>D</sub>	= 16 A	-	5.6	-	S
Dynamic	-					•		
Input Capacitance	C <sub>iss</sub>		$V_{cc} = 0.1$	1	-	4900	-	
Output Capacitance	Coss	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$		-	1			
Reverse Transfer Capacitance	C <sub>rss</sub>			-	4	-	1	
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>		( )		-	63	-	pF
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>	$V_{DS} = 0 V \text{ to } 520 V, V_{GS} = 0 V$		-	213	-		
Total Gate Charge	Qg				-	370	-	
Gate-Source Charge	Q <sub>gs</sub>	$V_{GS} = 10 \text{ V}$ $I_D = 20 \text{ A}, V_{DS} = 520 \text{ V}$ - 3.9 -		-	nC			
Gate-Drain Charge	Q <sub>gd</sub>				-	47	-	
Turn-On Delay Time	t <sub>d(on)</sub>				-	18	25	
Rise Time	t <sub>r</sub>	Voo	= 520 V. Ir	= 20A	-	24	55	ns
Turn-Off Delay Time	t <sub>d(off)</sub>		$V_{DD} = 520 \text{ V}, \text{ I}_{D} = 20 \text{ A},$		-	80	I	115
Fall Time	t <sub>f</sub>	$V_{GS}$ = 10 V, R <sub>g</sub> = 9.1 $\Omega$		-	12	-		
Gate Input Resistance	R <sub>g</sub>	f = 1	MHz, ope	n drain	-	0.8	-	Ω
Drain-Source Body Diode Characteristic	s							
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol		47				
Pulsed Diode Forward Current	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	140	A	
Diode Forward Voltage	V <sub>SD</sub>	T <sub>.1</sub> = 25 °	C, I <sub>S</sub> = 8 A	, V <sub>GS</sub> = 0 V	-	-	1.5	V
Reverse Recovery Time	t <sub>rr</sub>		, , ,		-	520	-	ns
Reverse Recovery Charge	Q <sub>rr</sub>	$T_J = 2$	25 °C, I <sub>F</sub> =	I <sub>S</sub> = 8 A,		5.8	_	μC
Reverse Recovery Current	I <sub>RRM</sub>	dl/dt = <sup>-</sup>	100 A/µs, \	$V_{\rm R} = 400  {\rm V}$		4 5		μ0 A

#### Notes

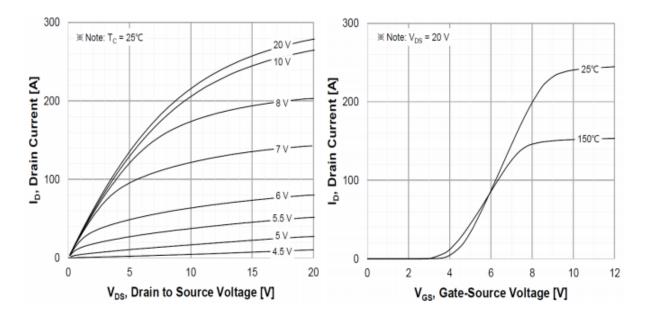
a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ . b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .



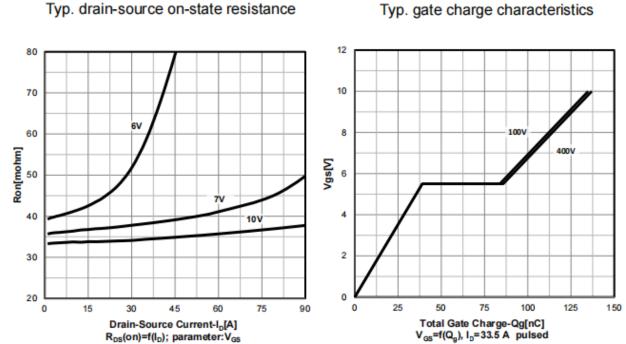


Typ. output characteristics  $T_i$ =25  $^{\circ}C$ 

Transfer characteristics



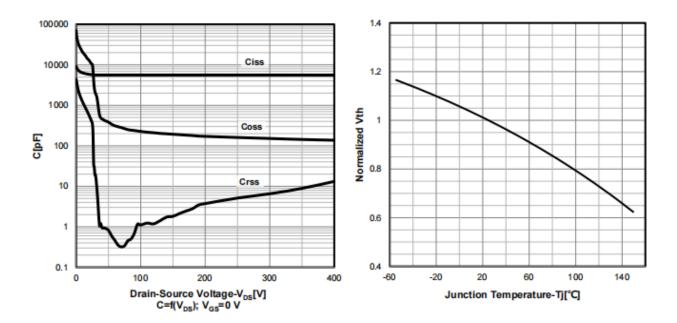




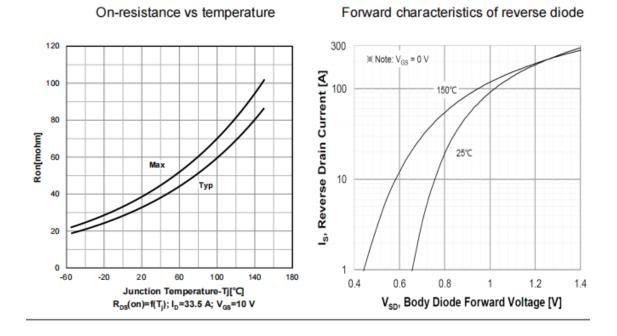
### Typ. drain-source on-state resistance

Typ. capacitances

Normalized  $V_{GS(th)}$  characteristics

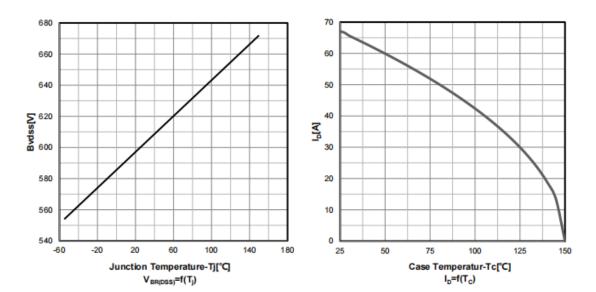






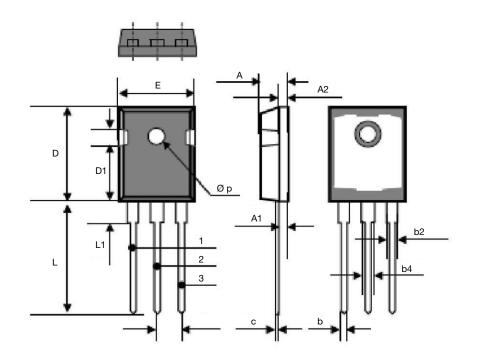
Drain-source breakdown voltage

Drain current vs temperature





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DIM	MILLIN	<b>METERS</b>	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.70	5.31	0.185	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.50	2.49	0.059	0.098	
b	0.99	1.40	0.039	0.055	
b2	1.65	2.41	0.065	0.095	
b4	2.59	3.43	0.102	0.135	
С	0.61 BSC		0.024 BSC		
D	20.80	21.46	0.819	0.845	
D1	3.68	5.49	0.145	0.216	
(e)	5.46 BSC		0.215 BSC		
E	15.49	16.26	0.610	0.640	
L	19.81	20.32	0.780	0.800	
L1	4.06	4.50	0.160	0.177	
Øp	3.51	3.66	0.138	0.144	



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